



NIC Components Corp.

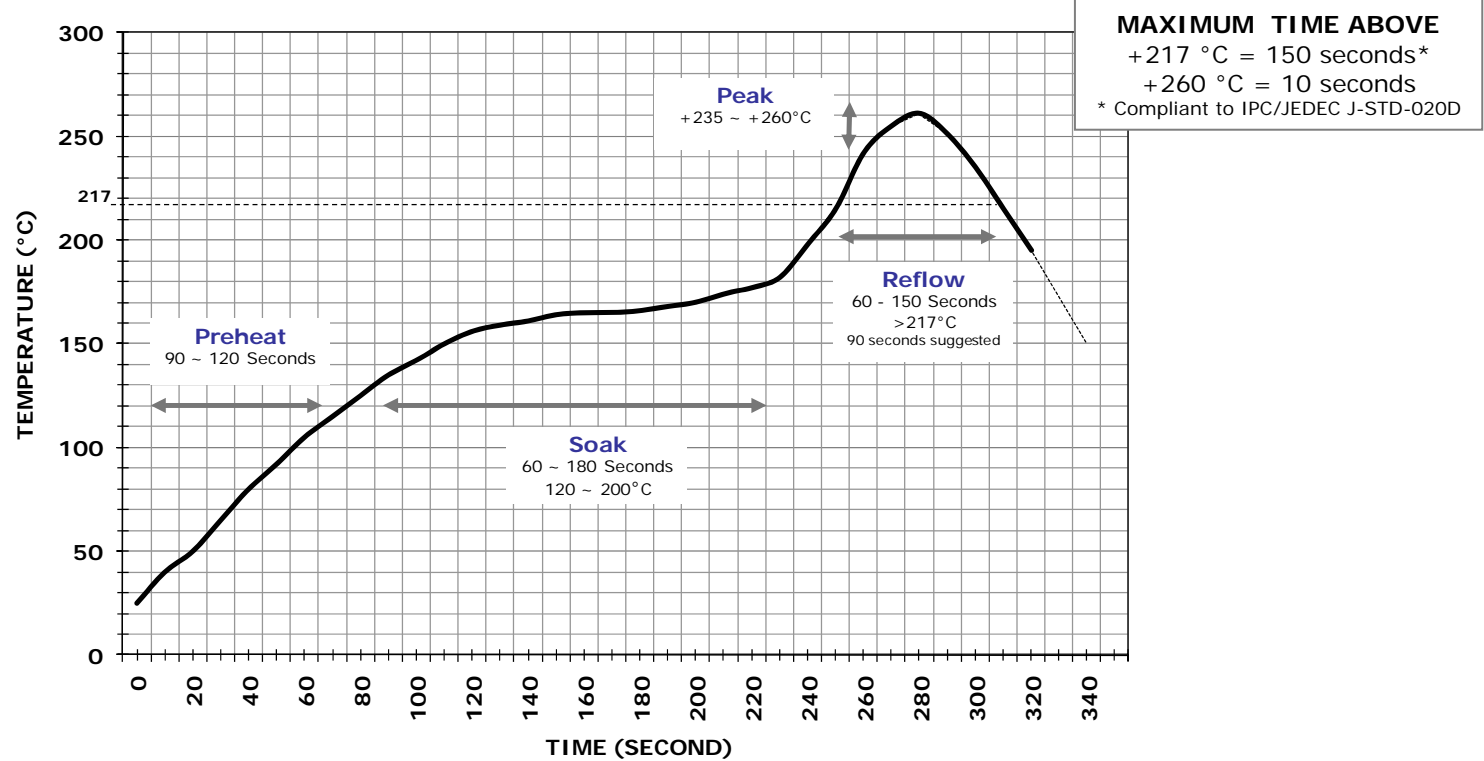
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NIC Pb-Free Profile_0711

Pb-Free Reflow Soldering Profile

The following NIC product series meet the below (Sn-Ag-Cu "SAC" Alloy) Pb-Free reflow soldering profile:

NMC, NMC-H, NMC-L, NMC-M, NMC-P, NMC-Q & NCA Series
SMT MLCC Ceramic Chip Capacitors and Arrays



Environmental Documentation:

IP-1752 Forms, Green Statements, Pb-Free Soldering Profiles are available on NIC website: www.niccomp.com/rohs

If in doubt, please review your Soldering Profile with NIC Personnel:

NIC Global Locations: [[link](#)]
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